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# Advances in Drying Technologies—Selected Papers from the 22nd International Drying Symposium (IDS 2022)

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Deadline for manuscript submissions:

closed (15 July 2023)

## **Message from the Guest Editors**

Dear Colleagues,

The authors of papers presented in the 22<sup>nd</sup> International Drying Symposium (IDS) are encouraged to submit their papers to *Processes* for potential publication in the Special Issue dedicated to the IDS 2022.

The IDS 2022 aimed to provide the most advanced and comprehensive global forum for disseminating results and data in research, development, and applications in drying/dewatering sciences and technologies. The IDS 2022 was held on June 26–29, 2022, in Worcester, USA. https://wp.wpi.edu/ids2022/.

Prof. Dr. Jamal Yagoobi Prof. Dr. Evangelos Tsotsas *Guest Editors* 











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# **Message from the Editor-in-Chief**

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